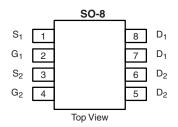




N- and P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY							
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
N-Channel	30	$0.047 \text{ at V}_{GS} = 10 \text{ V}$	6.0	2.75			
		0.065 at $V_{GS} = 4.5 \text{ V}$	5.2	2.75			
P-Channel	nnel - 30	0.089 at $V_{GS} = -10 \text{ V}$	- 4.3	4.1			
r-Chaine		0.140 at $V_{GS} = -4.5$ V	- 3.4	4.1			



Ordering Information: Si4532CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

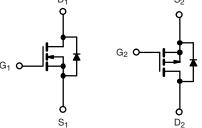
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_q Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN **FREE**

APPLICATIONS

- DC/DC Conve
- Load Switch



N-Channel MOSFET

P-Channel MOSFET

Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	30	- 30	V	
Gate-Source Voltage	V_{GS}	± 20			
	T _C = 25 °C		6.0	- 4.3	
Continuous Drain Current /T 150 °C)	T _C = 70 °C		4.9	- 3.4	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		4.9 ^{b, c}	- 3.4 ^{b, c}	
	T _A = 70 °C		3.9 ^{b, c}	- 2.7 ^{b, c}	
Pulsed Drain Current (10 μs Pulse Width)	I _{DM}	24	- 15	Α	
	T _C = 25 °C		2.3	- 2.3	
Source-Drain Current Diode Current	T _A = 25 °C	- I _S -	1.5 ^{b, c}	- 1.5 ^{b, c}	
Pulsed Source-Drain Current	I _{SM}	24	- 12		
Single Pulse Avalanche Current		I _{AS}	7	8	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	2.5	3.2	mJ
	T _C = 25 °C		2.78	2.78	
Manifestor Brown Bircharting	T _C = 70 °C		1.78	1.78	147
Maximum Power Dissipation	T _A = 25 °C	P _D	1.78 ^{b, c}	1.78 ^{b, c}	W
	T _A = 70 °C		1.14 ^{b, c}	1.14 ^{b, c}	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 1	°C		

THERMAL RESISTANCE RATINGS									
		N-Channel P-Channel			annel				
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^{b, d} t ≤ 10 s		R _{thJA}	57	70	57	70	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	37	45	37	45			

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- d. Maximum under steady state conditions is 120 °C/W (N-Channel) and 110 °C/W (P-Channel).

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit		
Static					•		,	
Drain Source Breekdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	N-Ch	30			V	
Drain-Source Breakdown Voltage	V DS	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	P-Ch	- 30			ľ	
V _{DS} Temperature Coefficient	AV/T	I _D = 250 μA	N-Ch		33			
VDS Temperature Coemicient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA	P-Ch		- 33		1	
V Tomporature Coefficient	AV /T	I _D = 250 μA	N-Ch		- 5.8		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	II _D = - 250 μA	P-Ch		4.5			
Cata Cauraa Threahald Valtage	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	1.0		3.0	1	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	P-Ch	- 1.0		- 3.0	V	
Gate-Body Leakage	looo	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			100	nΔ	
Gate-Body Leakage	I _{GSS}		P-Ch			- 100	nA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1	Ι.Δ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1		
zero date voltage Diam ourrent	DSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	N-Ch			5	- μA -	
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	P-Ch			- 5		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20			А	
		V _{DS} = - 5 V, V _{GS} = - 10 V	P-Ch	- 12				
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$	N-Ch		0.038	0.047	Ω	
		V _{GS} = - 10 V, I _D = - 3.5 A	P-Ch		0.073	0.089		
Orain-Source On-State Resistance ^b		$V_{GS} = 4.5 \text{ V}, I_D = 2.8 \text{ A}$	N-Ch		0.052	0.065		
		V _{GS} = - 4.5 V, I _D = - 2.5 A	P-Ch		0.113	0.140		
b	9 _{fs}	V _{DS} = 15 V, I _D = 2.5 A	N-Ch		7			
Forward Transconductance ^b		V _{DS} = - 15 V, I _D = - 3.5 A	P-Ch		7		S	
Dynamic ^a						I.		
nnut Conscitones	<u> </u>		N-Ch		305			
nput Capacitance	C _{iss}	N-Channel	P-Ch		340			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		65		рF	
	-055	P-Channel	P-Ch		67		-	
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		29			
·		V 45 V V 40 V L 0.5 A	P-Ch		51			
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$	N-Ch		6	9		
Total Gate Charge	Q _g	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$	P-Ch		7.8	12	n(
		N-Channel	N-Ch		2.75	4.5		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V} I_D = 2.5 \text{ A}$	P-Ch N-Ch		4.1 1.3	6.2		
Gate-Source Charge			P-Ch		1.3			
	Q _{gd}	P-Channel $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.5 \text{ A}$	N-Ch		0.9			
Gate-Drain Charge		v _{DS} 13 v, v _{GS} 4.3 v, I _D = - 2.5 A	P-Ch		1.8		1	
Outs Devictors	Б			0.6	3.1	6.2	 	
Gate Resistance	R_g	f = 1 MHz	N-Ch P-Ch	2.0	10	20	Ω	



SPECIFICATIONS $(T_J = 25)^\circ$	C, unless	s otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Dynamic ^a							
Turn-On Delay Time	t _{d(on)}	N. Channal	N-Ch		7	11	
	-u(on)	N-Channel $V_{DD} = 15 \text{ V, } R_{I} = 15 \Omega$	P-Ch		5.5	10	
Rise Time	t _r	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$	N-Ch		12	18	
		D / GEN - / g	P-Ch		13	25	
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch		14	25	
•	=(=,	$V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$	P-Ch		17	30	
Fall Time	t _f	$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	N-Ch		6	10	- ns -
			P-Ch		7.7	15	
Turn-On Delay Time	t _{d(on)}	N-Channel	N-Ch		16	30	
<u>, </u>	u(on)	$V_{DD} = 15 \text{ V, R}_{L} = 15 \Omega$	P-Ch		40	60	
Rise Time	t _r	$I_D \cong 1 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_q = 1 \Omega$	N-Ch P-Ch		16	30	
					40	60	
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch		9	18	
	-(/	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$	P-Ch		20	40	
Fall Time	t _f	$I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	N-Ch		9	18	
Dunin Carres Bady Diada Charactari	otico		P-Ch		17	30	
Drain-Source Body Diode Characteri	Stics	T	N Ch		l	0.0	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	N-Ch P-Ch			2.3	A
Current			N-Ch			- 2.3 24	
Pulse Diode Forward Current ^a			P-Ch			- 12	
	V _{SD}	I _S = 1.25 A	N-Ch		0.8	1.2	
Body Diode Voltage		$I_{S} = -0.75 \text{ A}$	P-Ch		- 0.8	- 1.2	V
	t _{rr}	IS = - 0.75 A	N-Ch		14	21	
Body Diode Reverse Recovery Time			P-Ch		17	30	ns
	e Q _{rr}	N-Channel	N-Ch		6	10	
Body Diode Reverse Recovery Charge		$I_F = 1.25 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	P-Ch		11	20	nC
			N-Ch		9		
Reverse Recovery Fall Time	t _a	P-Channel $I_F = -2.5 \text{ A}$, $dI/dt = -100 \text{ A/}\mu\text{s}$, $T_J = 25 ^{\circ}\text{C}$	P-Ch		12		1
	t _b] I _F = -2.5 A, αΙ/αι = - 100 A/μs, 1 _J = 25 °C	N-Ch		5		ns
Reverse Recovery Rise Time			P-Ch		5		
			. 011		U		

Notes:

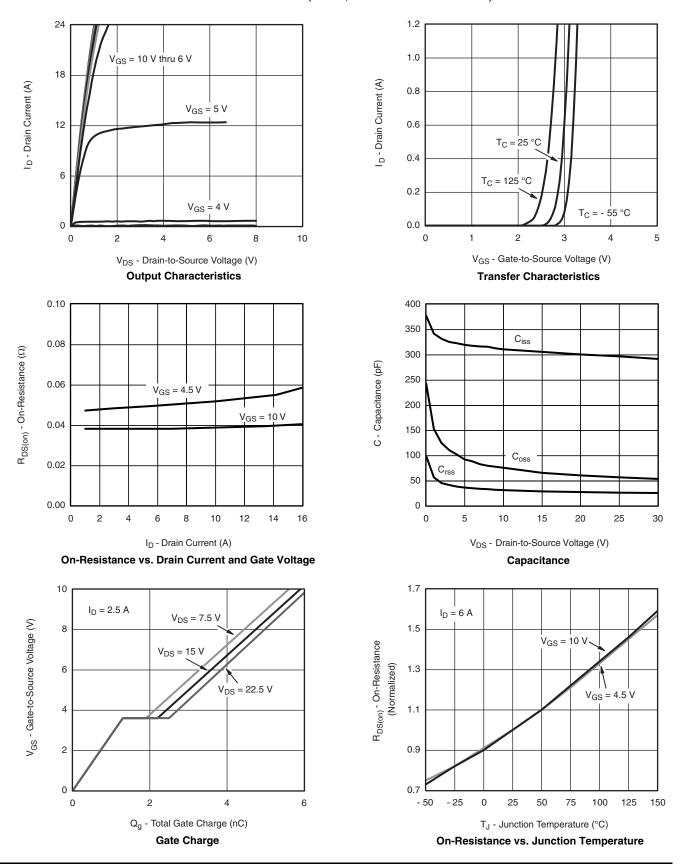
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

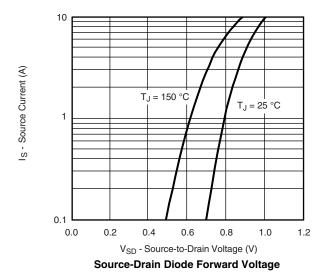
VISHAY

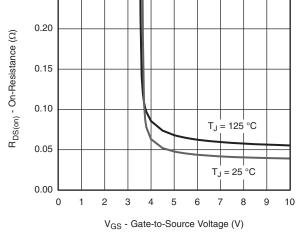
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





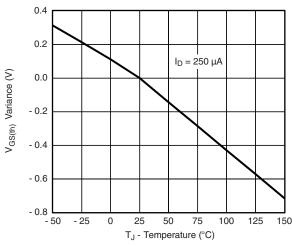
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



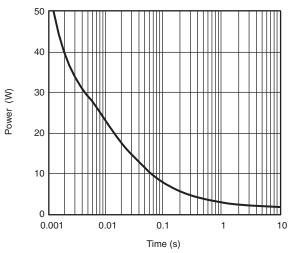


0.25

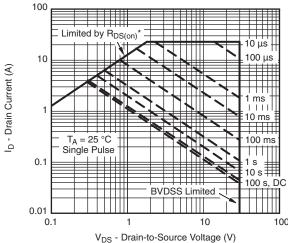
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



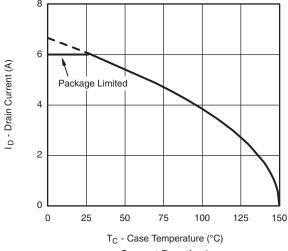
Single Pulse Power, Junction-to-Ambient



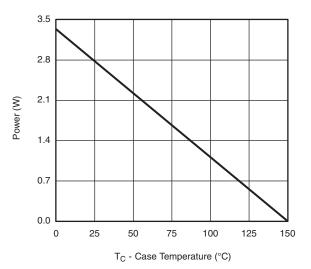
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

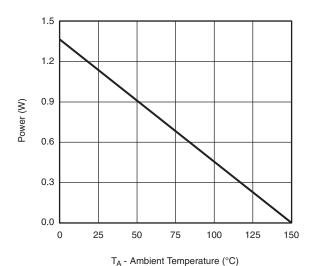
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





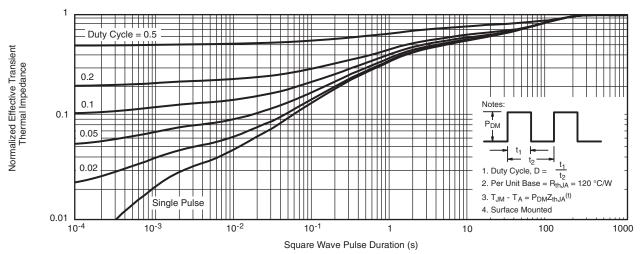


Power Derating, Junction-to-Ambient

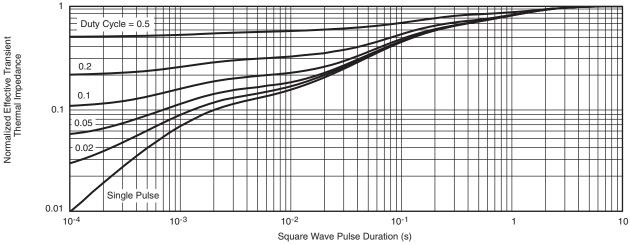
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



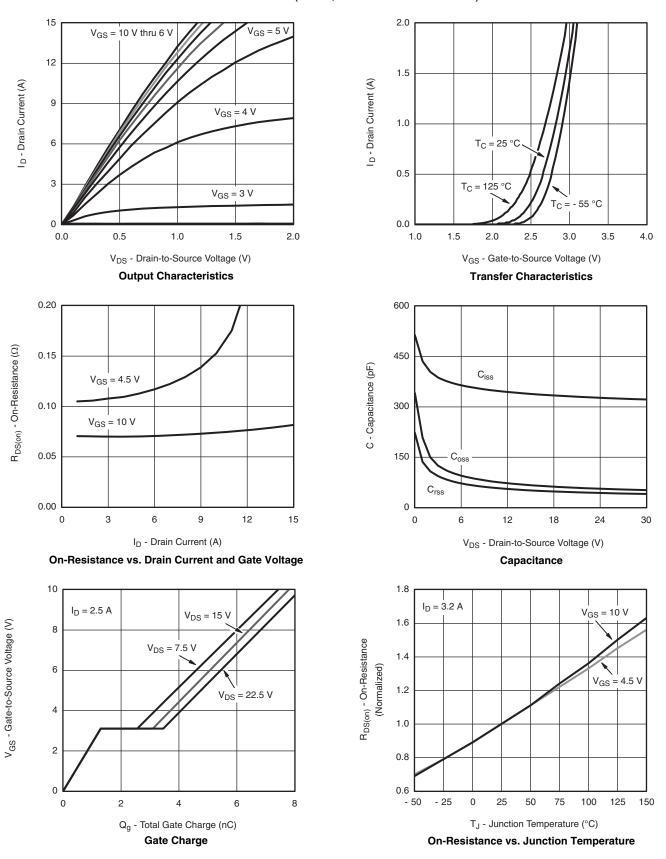
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



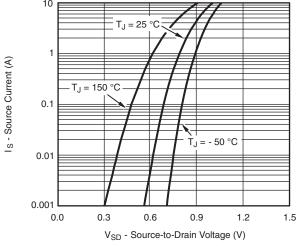
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



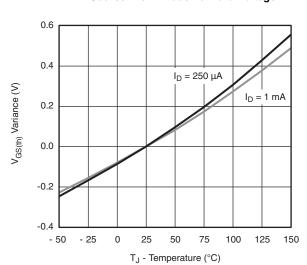
10



P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Source-Drain Diode Forward Voltage



Threshold Voltage

R_{DS(on)} - On-Resistance (Ω) 0.1 T_J = 25 °C 0.0

0.4

0.3

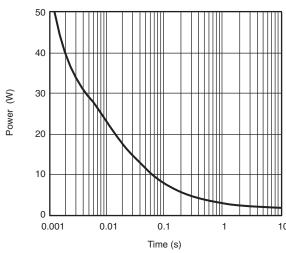
0.2

0

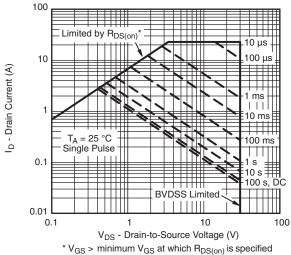
 $I_D = 3.5 \text{ A}$



T_J = 125 °C

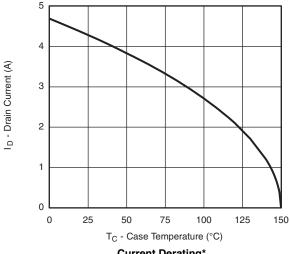


Single Pulse Power, Junction-to-Ambient

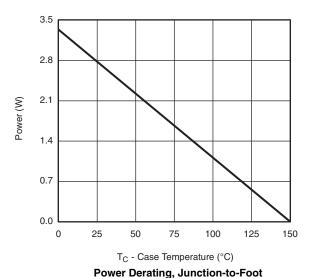


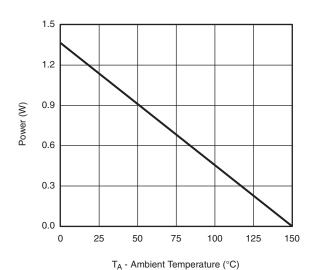
Safe Operating Area, Junction-to-Ambient

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*



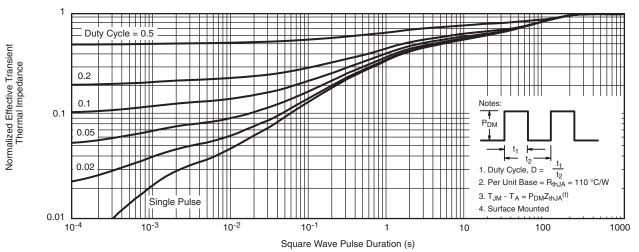


Power Derating, Junction-to-Ambient

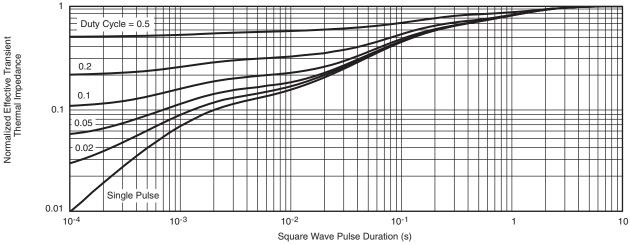
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heats inking is used. It is used to determine the current rating, when this rating falls below the package limit.



P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

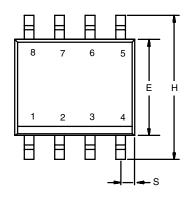


Normalized Thermal Transient Impedance, Junction-to-Foot

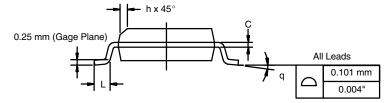
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Document Number: 64805 S11-0652-Rev. B, 11-Apr-11

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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